



#### N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BVDSS	Rds(on)	I <sub>D</sub> T <sub>A</sub> = +25°C
30V	5Ω @ V <sub>GS</sub> = 4V	200mA
307	7Ω @ V <sub>GS</sub> = 2.5V	115mA

### **Description**

This new generation MOSFET has been designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

- DC-DC Converters
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

#### **Features**

- N-Channel MOSFET
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate 2kV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Qsuffix) part. A listing can be found at <a href="https://www.diodes.com/products/automotive/automotive-products/">https://www.diodes.com/products/automotive/automotive-products/</a>.
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
   https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMN33D8LTQ</u>)

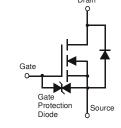
#### **Mechanical Data**

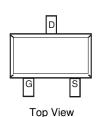
- Case: SOT523
- Case Material: Molded Plastic. "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed Over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 ©3
- Terminal Connections: See Diagram
- Weight: 0.002 grams (Approximate)





Top View





**Equivalent Circuit** 

### **Ordering Information** (Note 4)

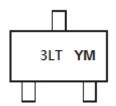
Part Number	Case	Packaging
DMN33D8LT-7	SOT523	3,000/Tape & Reel
DMN33D8LT-13	SOT523	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



## **Marking Information**



3LT = Product Type Marking Code YM = Date Code Marking Y = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key

Year	2014		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	В			J	K	L	М	N	0	Р	R	S
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec

## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		$V_{DSS}$	30	V
Gain-Source Voltage		V <sub>GSS</sub>	±20	V
Drain Current (Note 5)	Continuous	I <sub>D</sub>	115	mA

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	240	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θ</sub> JA	521	°C/W
Total Power Dissipation (Note 6)	PD	300	mW
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>θ</sub> JA	420	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

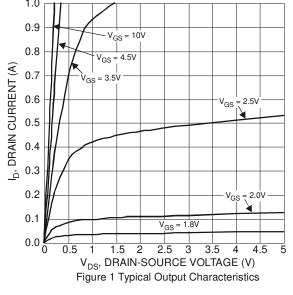


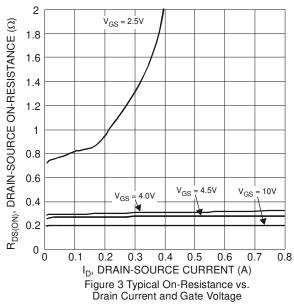
## **Electrical Characteristics** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30		_	V	$V_{GS} = 0V$ , $I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>			1.0	μΑ	$V_{DS} = 30V$ , $V_{GS} = 0V$	
Gate-Body Leakage	Igss			±10	μΑ	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.8		1.5	V	$V_{DS}=3V,I_{D}=100\mu A$	
Static Drain-Source On-Resistance	Dagger			5	Ω	$V_{GS} = 4V$ , $I_D = 10mA$	
Static Dialii-Source Oil-Nesistance	Rds(on)			7	Ω	$V_{GS} = 2.5V$ , $I_D = 5mA$	
Diode Forward Voltage	VsD	_	_	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 115mA	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	48	_			
Output Capacitance	Coss	_	11	_	pF	$V_{DS} = 5V$ , $V_{GS} = 0V$ , $f = 1.0MHz$	
Reverse Transfer Capacitance	Crss	_	8	_			
Total Gate Charge (VGS = 4.5V)	Qg	_	0.55	_			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	1.23	_	nC	\/ 10\/ I- 050m A	
Gate-Source Charge	Q <sub>gs</sub>	_	0.14	_	IIC	$V_{DS} = 10V, I_{D} = 250mA$	
Gate-Drain Charge	$Q_{gd}$	_	0.14	_			
Turn-On Delay Time	td(on)	_	2.9	_			
Turn-On Rise Time	t <sub>R</sub>	_	2.6	_		V <sub>DD</sub> = 30V, I <sub>D</sub> = 0.2A, V <sub>GEN</sub> = 10V,	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	18.2	_	ns	$R_{GEN} = 25\Omega$	
Turn-Off Fall Time	tF	_	13.6				

7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing. Notes:







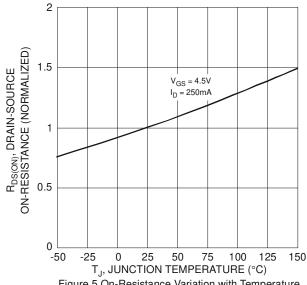
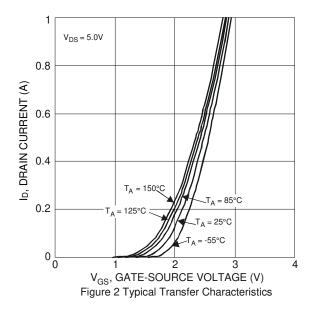
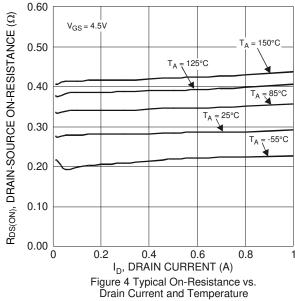


Figure 5 On-Resistance Variation with Temperature





0.5  $R_{DS(ON)},$  DRAIN-SOURCE ON-RESISTANCE  $(\Omega)$ 0.4  $V_{GS} = 4.5V$ 0.3 I<sub>D</sub> = 250mA 0.2 0.1 0 -50 -25 25 50 75 100 125 150 T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

Figure 6 On-Resistance Variation with Temperature



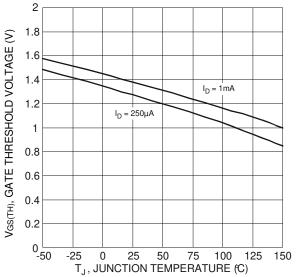
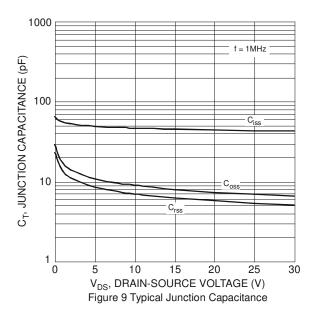
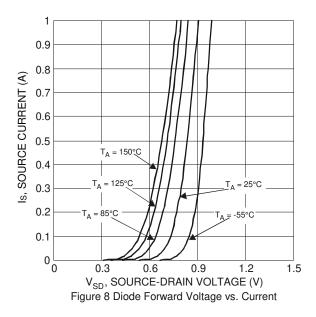
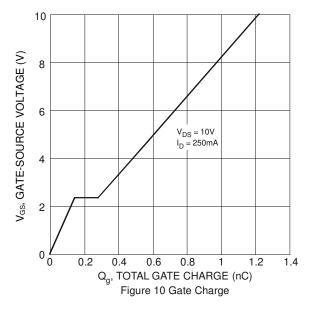


Figure 7 Gate Threshold Variation vs. Junction Temperature





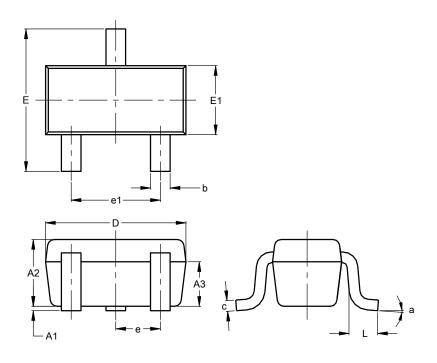




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT523

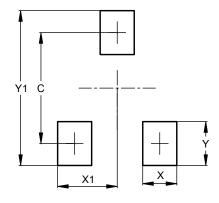


SOT523					
Dim	Min	Max	Тур		
A1	0.00	0.10	0.05		
A2	0.60	0.80	0.75		
A3	0.45	0.65	0.50		
b	0.15	0.30	0.22		
С	0.10	0.20	0.12		
D	1.50	1.70	1.60		
E	1.45	1.75	1.60		
E1	0.75	0.85	0.80		
е	0.50 BSC				
e1	0.90	1.10	1.00		
L	0.20	0.40	0.33		
а	0°		8°		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT523



Dimensions	Value (in mm)			
С	1.29			
Х	0.40			
X1	0.70			
Υ	0.51			
Y1	1.80			



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